



## CUSTOMER APPROVAL SHEET

<b>Company Name</b>	
<b>MODEL</b>	<b>A070XN01 V1</b>
<b>CUSTOMER APPROVED</b>	

- ☐ APPROVAL FOR SPECIFICATIONS ONLY (Spec. Ver. 0.0)
- ☐ APPROVAL FOR SPECIFICATIONS AND ES SAMPLE (Spec. Ver. 0.0)
- ☐ APPROVAL FOR SPECIFICATIONS AND CS SAMPLE (Spec. Ver. 0.0)
- ☐ CUSTOMER REMARK :

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Total pages :	32

# Product Specification

## 7.0" COLOR TFT-LCD MODULE

**Model Name :** **A070XN01 V0**

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<b>Planned Lifetime:</b>	From 2011/Apr To 2012/Apr
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<b>Phase-out Control:</b>	From 2011/Nov To 2011/Apr
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<b>EOL Schedule:</b>	2012/Apr
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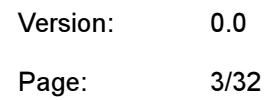
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< ☐ > Preliminary Specification

< ☐ > Final Specification

Note: The content of this specification is subject to change.

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## Contents

<b>A. General Information</b>	<b>5</b>
<b>B. Outline Dimension</b>	<b>6</b>
1. TFT-LCD Module – Front View	6
2. TFT-LCD Module – Rear View	7
<b>C. Electrical Specifications</b>	<b>8</b>
1. TFT LCD Panel Pin Assignment	8
2. The Input Data Format	10
(NS format , DE mode only )	10
3. Absolute Maximum Ratings	11
4. Electrical DC Characteristics	12
5. LVDS DC Characteristics	14
A. DC Characteristic	14
c. Recommended Power On/OFF Sequence	15
<b>D. Optical Specification</b>	<b>16</b>
<b>E. Reliability Test Items</b>	<b>19</b>
<b>F. Packing and Marking</b>	<b>22</b>
1. Packing Form	22
3. Carton Label Information	23
<b>G. Application Note</b>	<b>24</b>
1. Application Circuit	24
2. CABC function block	24
<b>H. Precautions</b>	<b>25</b>
<b>I. Touch Panel Command and Register Map</b>	<b>26</b>
1. I2C Protocol Definition	26
2. Coordinate Register Map	28
3. Display and Touch Resolution	28
4. True Two Multi-Touch	28
5. Sensitivity	28
6. Interrupt Operation Mode	29
7. Power Mode	31
8. Calibration	32

## A. General Information

This product is for CE Brand Tablet application.

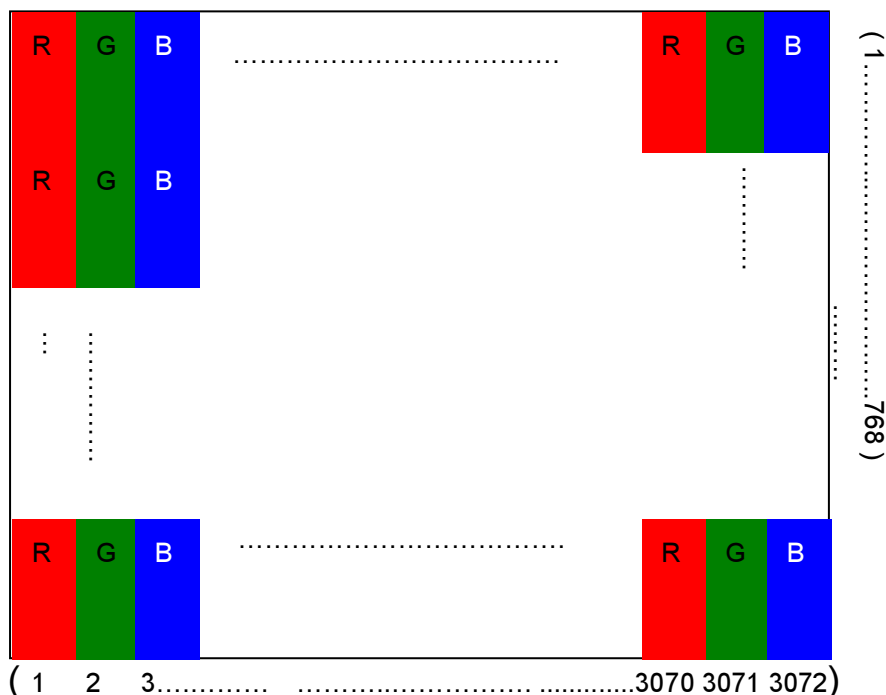
NO.	Item	Unit	Specification	Remark
1	Screen Size	inch	7(Diagonal)	
2	Display Resolution	dot	1024RGB(W)x768(H)	
3	Overall Dimension	mm	154(W) x119.2(H) x4.5(D)	Note 1
4	Active Area	mm	141.312(W) x 105.984(H)	
5	Pixel Pitch	mm	0.138(W)x0.138(H)	
6	Color Configuration	--	R. G. B. Stripe	Note 2
7	Color Depth	--	16.2M Colors	Note 3
8	NTSC Ratio	%	45	
9	Display Mode	--	Normally Black	
10	Panel surface Treatment	--	Anti-Glare, 3H	
11	Weight	g	180	
12	Panel Power Consumption	mW	170	Note 4
13	Backlight Power Consumption	W	1.8	
14	Viewing direction		MVA	

Note 1: Not include backlight cable and FPC. Refer next page to get further information.

Note 2: Below figure shows dot stripe arrangement.

Note 3: Please refer to Electrical Characteristics chapter.

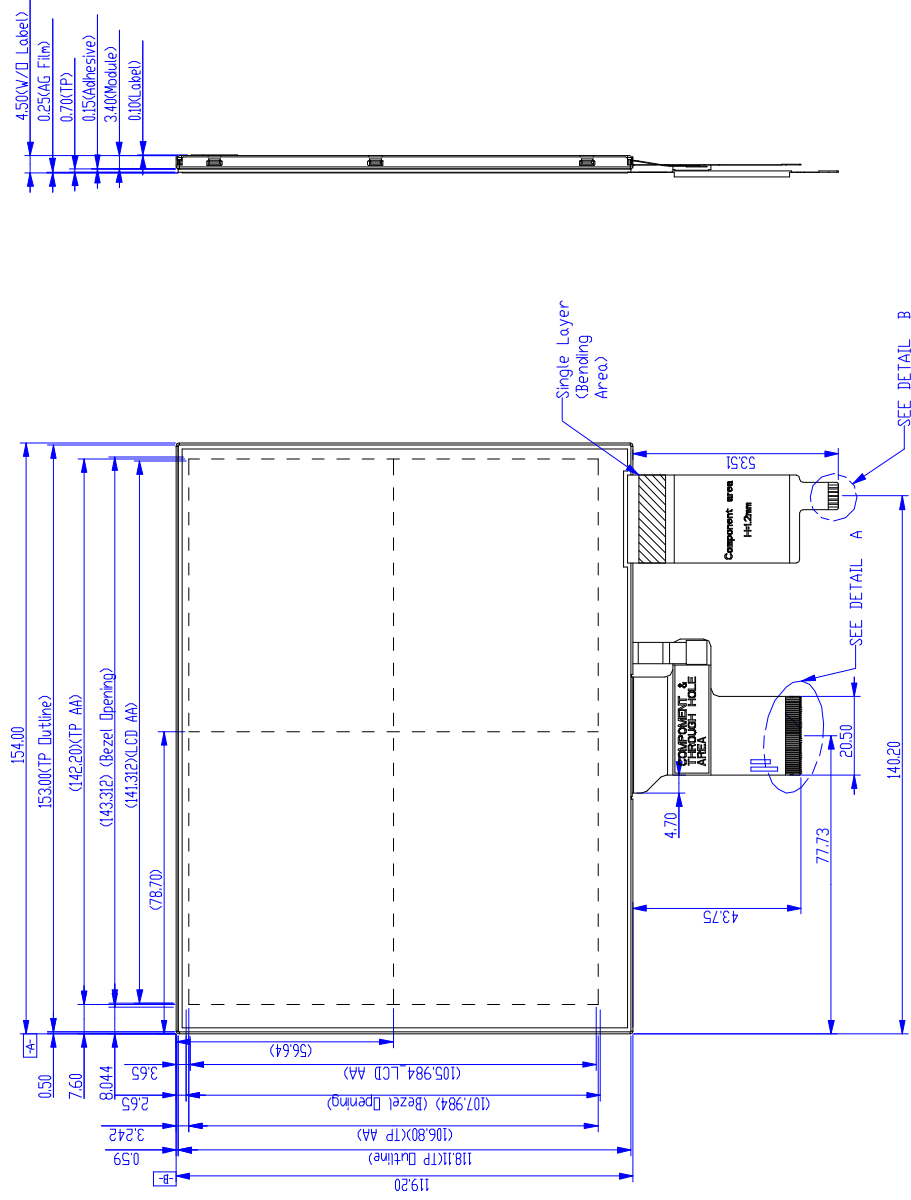
Note 4: Ref. Pattern at Page24



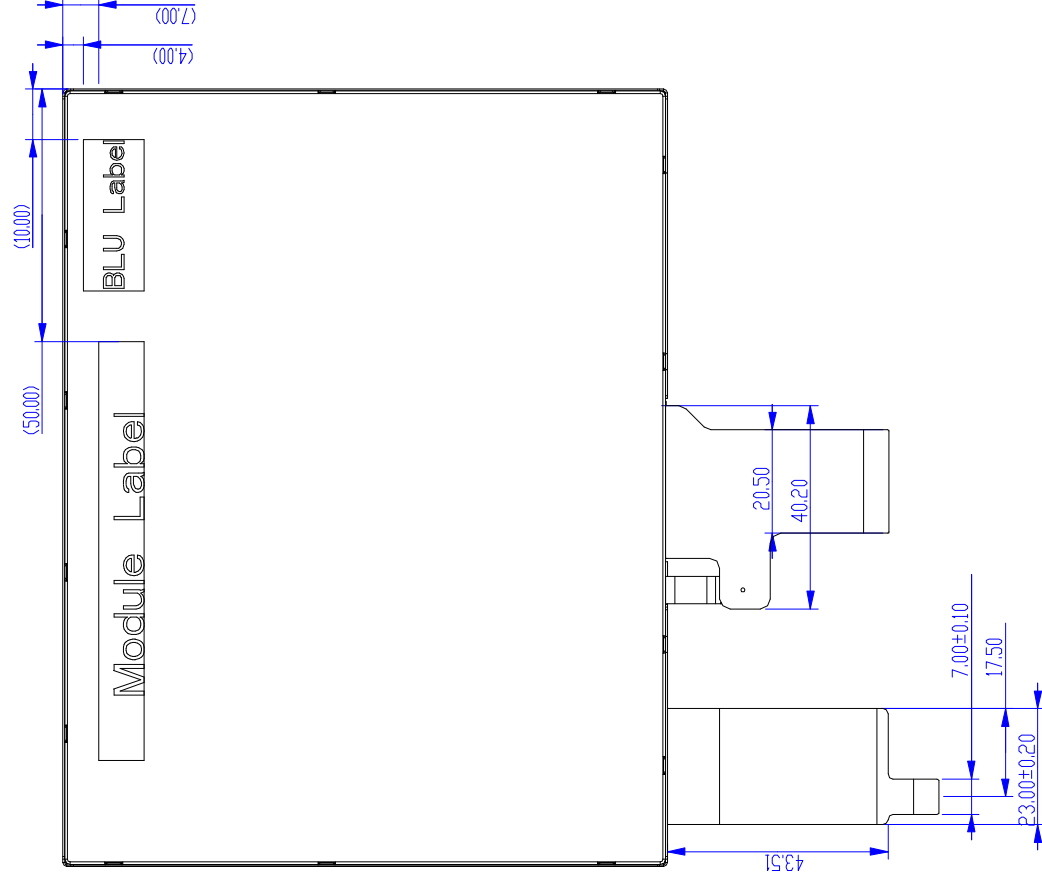
## B. Outline Dimension

### 1. TFT-LCD Module – Front View

NOTE:  
1.THE BENDING RADIUS OF FPC SHOULD BE LARGER THAN 0.6mm  
2.GENERAL TOLERANCE: ±0.3mm



## 2. TFT-LCD Module – Rear View



## C. Electrical Specifications

### 1. TFT LCD Panel Pin Assignment

Recommended connector : FH12A-40S-0.5SH(55)

NO.	Symbol	I/O	Description	Remark
1	VCOM	P	Common electrode driving voltage	
2	VDDIO	P	Digital interface supply voltage of digital	
3	VGL	P	Negative power supply voltage for Gate driver	
4	VGH	P	Positive power supply voltage for Gate driver	
5	U/D	I	Up/Down selection. 0:Enable,1:Disable	Note1
6	R/L	I	Left/Right selection. 0:Enable,1:Disable	Note1
7	GRB	I	H/W global reset. 0:Enable,1:Disable	Note2
8	STB	I	H/W Standby mode. 0:Enable,1:Disable	
9	GND	P	Ground	
10	NC	-	For test , do not connect (Please leave it open)	
11	NC	-	For test , do not connect (Please leave it open)	
12	CABC_EN	I	CABC function enable. 0:Disable,1:Enable	
13	VDPA	P	Positive power supply voltage for analog power	
14	VDNA	P	Negative power supply voltage for analog power	
15	VDDIO	P	Digital interface supply voltage of digital	
16	RxCLK-	I	LVDS receiver signal clock	
17	RxCLK+	I		
18	GND	P	Ground	
19	RxIN0-	I	LVDS receiver signal channel 0 LVDS Differential Data Input (R0, R1, R2, R3, R4, R5, G0)	
20	RxIN0+	I		
21	GND	P	Ground	
22	RxIN1-	I	LVDS receiver signal channel 1 LVDS Differential Data Input (G1, G2, G3, G4, G5, B0, B1)	
23	RxIN1+	I		
24	GND	P	Ground	
25	RxIN2-	I	LVDS receiver signal channel 2 LVDS Differential Data Input (B2, B3, B4, B5, HS, VS, DE)	
26	RxIN2+	I		
27	GND	P	Ground	
28	RxIN3-	I	LVDS receiver signal channel 3, LVDS Differential Data Input (R6, R7, G6, G7, B6, B7, RSV)	
29	RxIN3+	I		
30	GND	P	Ground	
31	DRV_BLU	O	OUTPUT_PWM_SIGNAL output via an output buffer	



32	VCOM	I	Common electrode driving voltage	
33	GND	P	Ground	
34	LEDN	P	LED cathode	
35	LEDN	P	LED cathode	
36	LEDN	P	LED cathode	
37	LEDP	P	LED anode	
38	LEDP	P	LED anode	
39	LEDP	P	LED anode	
40	GND	P	Ground	

I: Input; P: Power

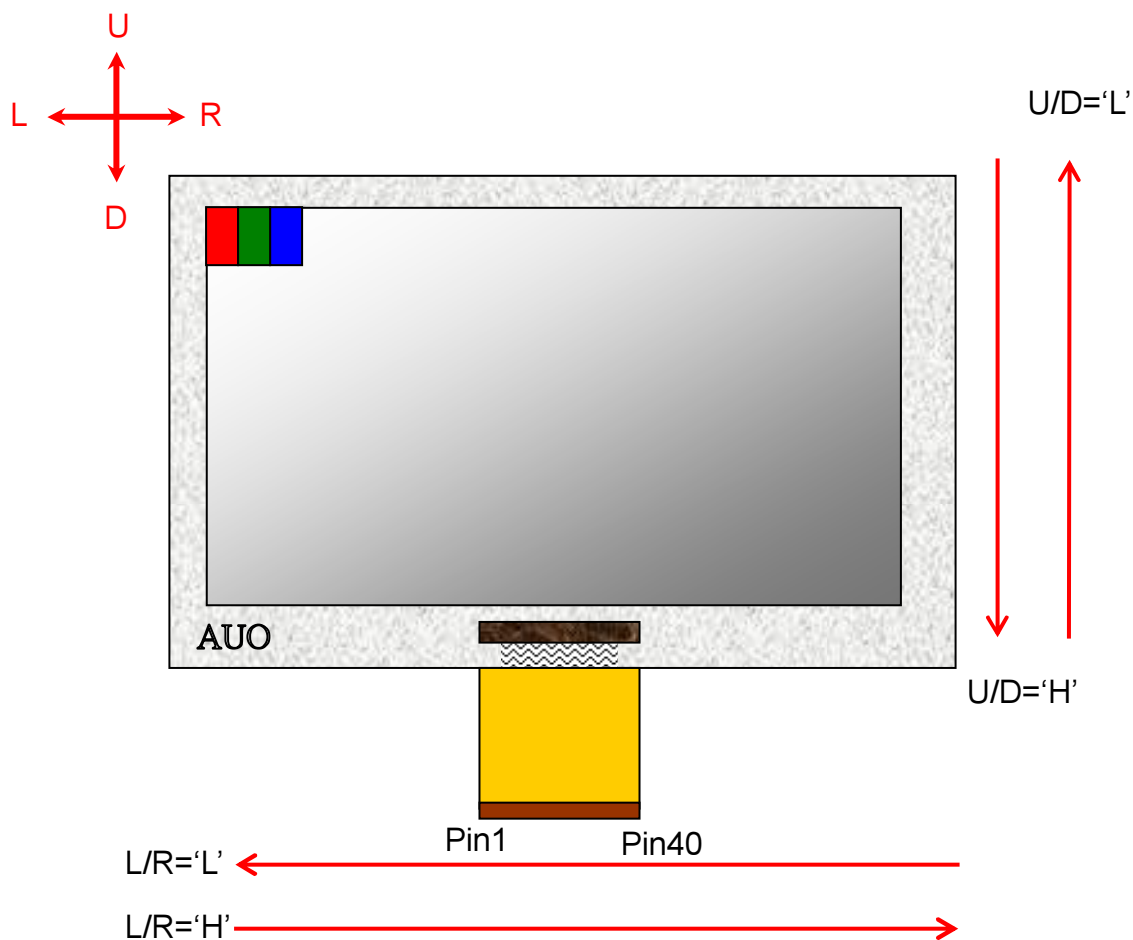
Note1:

U/D	Direction	L/R	Direction
H	U → D	H	L → R
L	D → U	L	R → L

Note2: Global reset, normally pulled high.

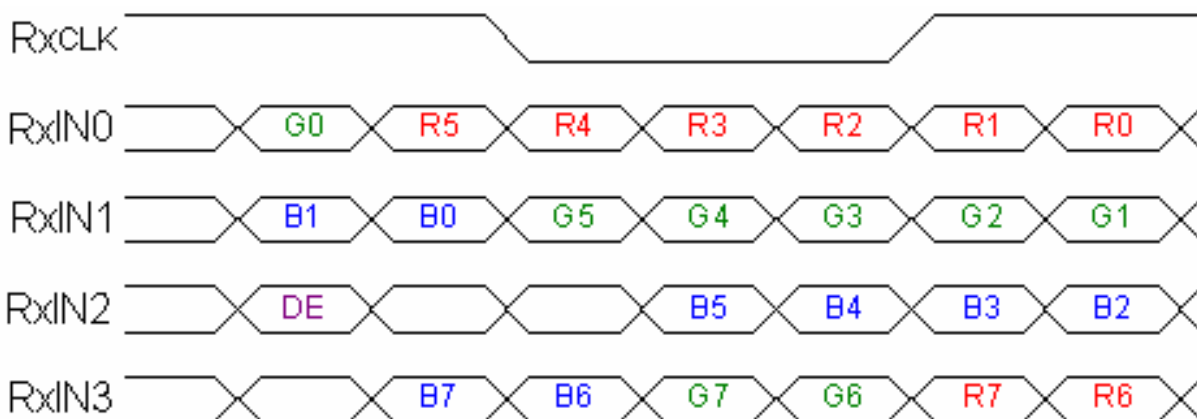
Suggest to connecting with an RC (R=10K ohm, C=1uF)reset circuit for stability.

Normally pull high.



## 2. The Input Data Format

(NS format , DE mode only )



Signal Name	Description	Remark
-------------	-------------	--------

R7~R0	Red Data 7 ~ Red Data 0	Red-pixel Data For 8Bits LVDS input MSB: R7 ; LSB: R0
G7~G0	Green Data 7 ~ Green Data 0	Green-pixel Data For 8Bits LVDS input MSB: G7 ; LSB: G0
B7~B0	Blue Data 7 ~ Blue Data 0	Blue-pixel Data For 8Bits LVDS input MSB: B7 ; LSB: B0
RxCLKIN	LVDS Data Clock	
DE	Data Enable Signal	When the signal is high, the pixel data shall be valid to be displayed.

### 3. Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power Voltage	VDDIO	GND=0	-0.5	5	V	
	VDPA	GND=0	-0.5	6	V	
	VDNA	GND=0	-6	0.5	V	
	VGH	GND=0	-0.3	45	V	
	VGL	GND=0	-20	+0.3	V	
	VGH – VGL		-	40	V	
Operating temperature	Topa		-10	60	°C	
Storage temperature	Tstg		-20	70	°C	

Note 1: Maximum ratings are those values beyond which damages to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics chapter.

Note 2: Functional operation should be restricted under ambient temperature (25°C).

## 4. Electrical DC Characteristics

### a. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Power supply	VDDIO	3	3.3	3.6	V	
	VDPA	5.1	5.3	5.5	V	
	VDNA	-5.5	-5.3	-5.1	V	
	VGH	13.5	14	14.5	V	
	VGL	-12.5	-12	-11.5	V	
VCOM	Vcdc	--	-1.8	--	V	Note 1
Input signal voltage	H Level	Vih	0.7xVDDIO	--	VDDIO	V
	L Level	Vil	0	--	0.3xVDDIO	V
Pull-up/down impedance	Rin	--	250k	--		

Note 1: VCOM < 0

### b. Current Consumption (AGND=GND=0V)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Input current for VDDIO	IVDDIO	VDDIO=3.3V	-	17	20	mA	Note 1
Input current for VDPA	IVDPA	VDPA=5.3V	-	10	12	mA	Note 1
Input current for VDNA	IVDNA	VDNA=-5.3V	-	10	12	mA	Note 1
Input current for VGH	IVGH	VGH=14V	-	0.3	0.5	mA	Note 1
Input current for VGL	IVGL	VGL=-12V	-	0.2	0.4	mA	Note 1
Input Leakage Current	Iin	Digital input pins	-	-	±1	uA	Note 2

Note 1: The test pattern use the following pattern.



Note 2: except for pull-up, pull-down pins.

### c. Backlight Driving Conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED Lightbar current	I <sub>L</sub>	-	180	-	mA	Note 1, 2
Power consumption	P		1.8	-	W	
LED Lightbar life time		15,000	-	-	Hr	Note 1, 2, 3, 4

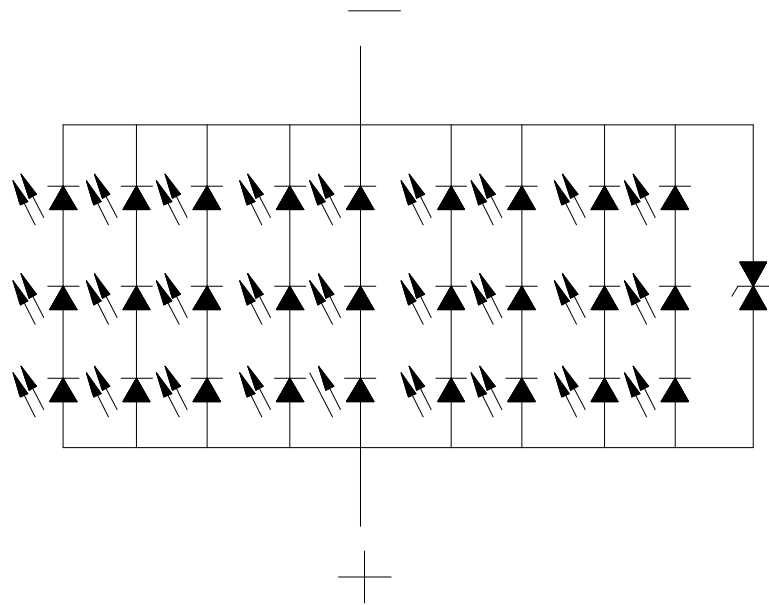
Note 1: LED backlight is LED lightbar type(27 pcs of LED).

Note 2: Definition of "LED Lifetime": brightness is decreased to 50% of the initial value. LED Lifetime is

restricted under normal condition, ambient temperature = 25°C and LED lightbar current= 180mA

Note 3: The value is only for reference.

Note 4: If it operates with LED lightbar voltage more than 180mA, it maybe decreases LED lifetime.



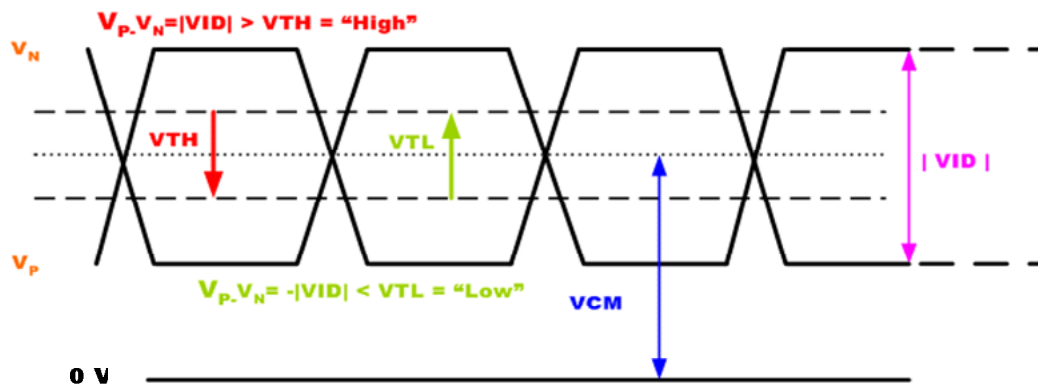
## 5. LVDS DC Characteristics

Symbol	Item	Min.	Typ.	Max.	Unit	Remark
<b>VTH</b>	Differential Input High Threshold	-	-	100	[mV]	VCM=1.25V
<b>VTL</b>	Differential Input Low Threshold	100	-	-	[mV]	VCM=1.25V
<b>  VID  </b>	Input Differential Voltage	100	350	600	[mV]	
<b>VICM</b>	Differential Input Common Mode Voltage	1.1	-	1.45	[V]	VTH/VTL=+-100mV

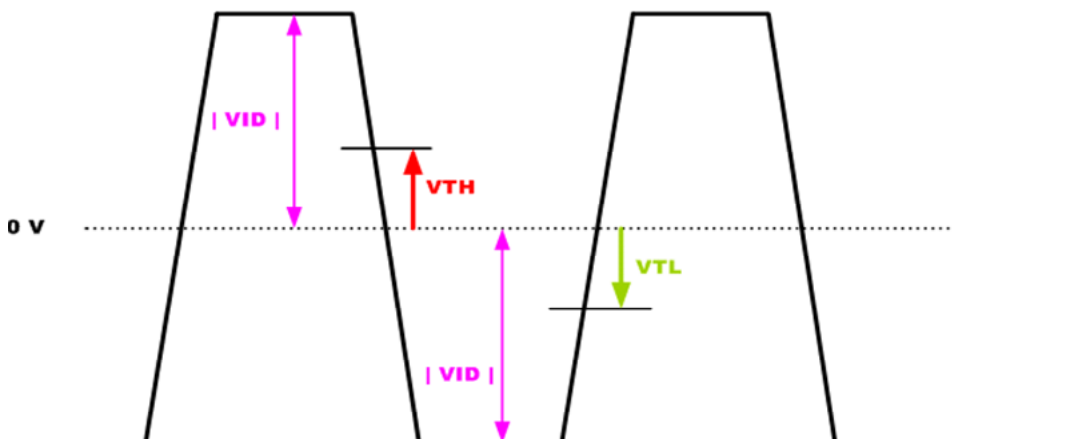
### A. DC Characteristic

Input signals shall be low or Hi-Z state when VDD is off.

#### Single-end Signal



#### Differential Signal

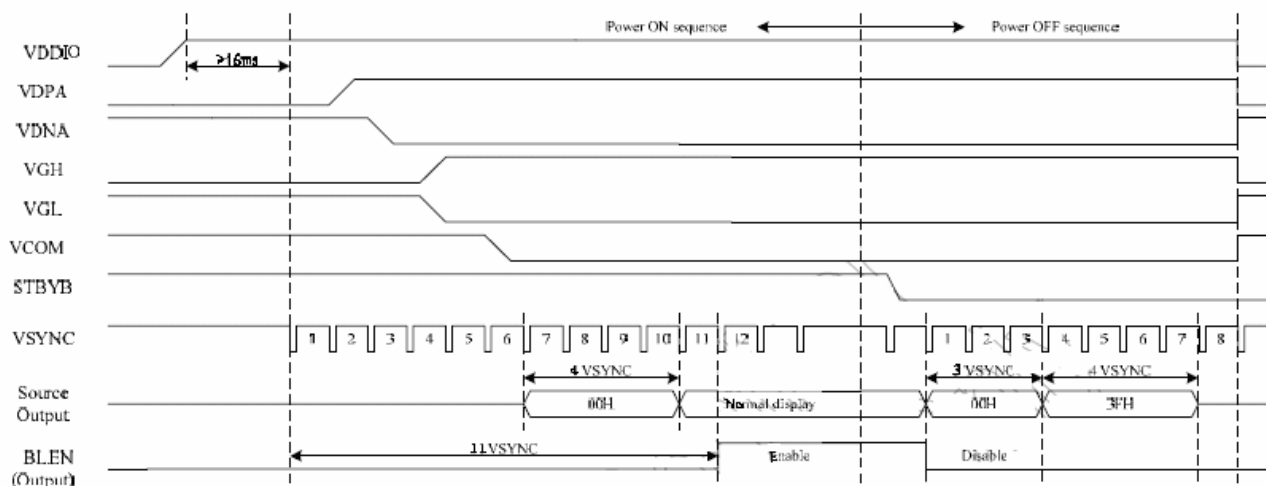


## B. Input Timing Setting

Parameter	Symbol	Min.	Typ.	Max.	Unit.	Remark
DCLK frequency	Fdclk	52	65	71	MHz	Frame rate=60Hz
Hsync period (= Thd + Thbl)	Th	1114	1344	1400	DCLK	
Active Area	Thd	--	1024	--	DCLK	
Horizontal blanking	Thbl	90	320	376	DCLK	
Vsync period (= Tvd + Tvbl)	Tv	778	806	845	Th	
Active lines	Tvd	--	768	--	Th	
Vertical blanking	Tvbl	10	38	77	Th	

## c. Recommended Power On/OFF Sequence

Power-On/Off Timing Sequence:



## D. Optical Specification

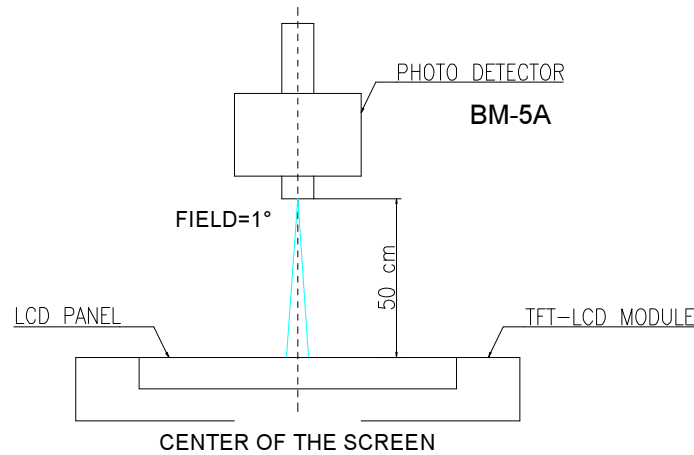
All optical specification is measured under typical condition (Note 1, 2)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Response Time	Tr			15	18		
Rise	Tf	$\theta=0^\circ$	--	10	12	ms	Note 3
Fall			--			ms	
Contrast ratio	CR	At optimized viewing angle	--	600	--		Note 4
Viewing Angle		$CR \geq 10$	70	80		deg.	Note 5
Top			70	80			
Bottom			70	80			
Left			70	80			
Right			70	80			
Brightness	$Y_L$	$V_L = 12V$	230	290	--	cd/m <sup>2</sup>	Note 6
Chromaticity	White	X	$\theta=0^\circ$	0.26	0.31	0.36	
		Y	$\theta=0^\circ$	0.29	0.34	0.39	
	Red	X	$\theta=0^\circ$	TBD	TBD	TBD	
		Y	$\theta=0^\circ$	TBD	TBD	TBD	
	Green	X	$\theta=0^\circ$	TBD	TBD	TBD	
		Y	$\theta=0^\circ$	TBD	TBD	TBD	
	Blue	X	$\theta=0^\circ$	TBD	TBD	TBD	
		Y	$\theta=0^\circ$	TBD	TBD	TBD	
Uniformity	$\Delta Y_L$	%	70	75	--	%	Note 7

Note 1 : To be measured in the dark room. Ambient temperature =25°C, and LED lightbar current  $I_L = 180mA$ .

Note 2 :To be measured on the center area of panel with a viewing cone of 1°by Topcon luminance meter BM-5A, after 15 minutes operation.

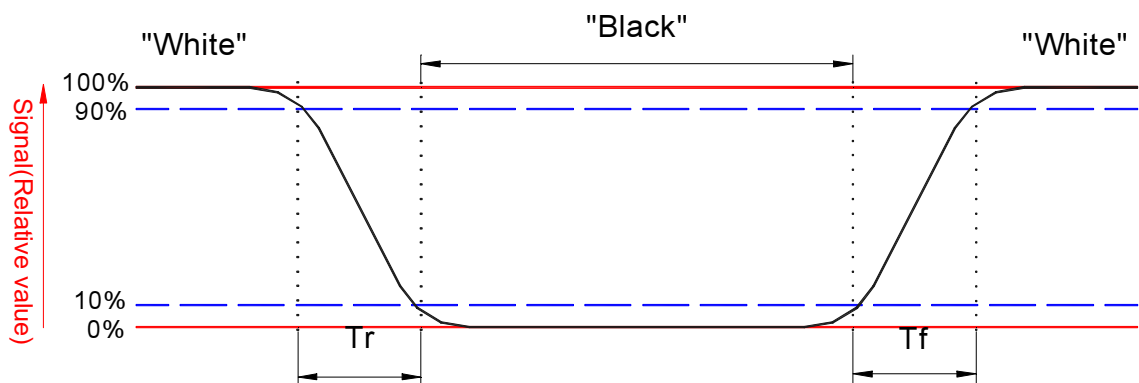




**Note 3: Definition of response time:**

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively.

The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.

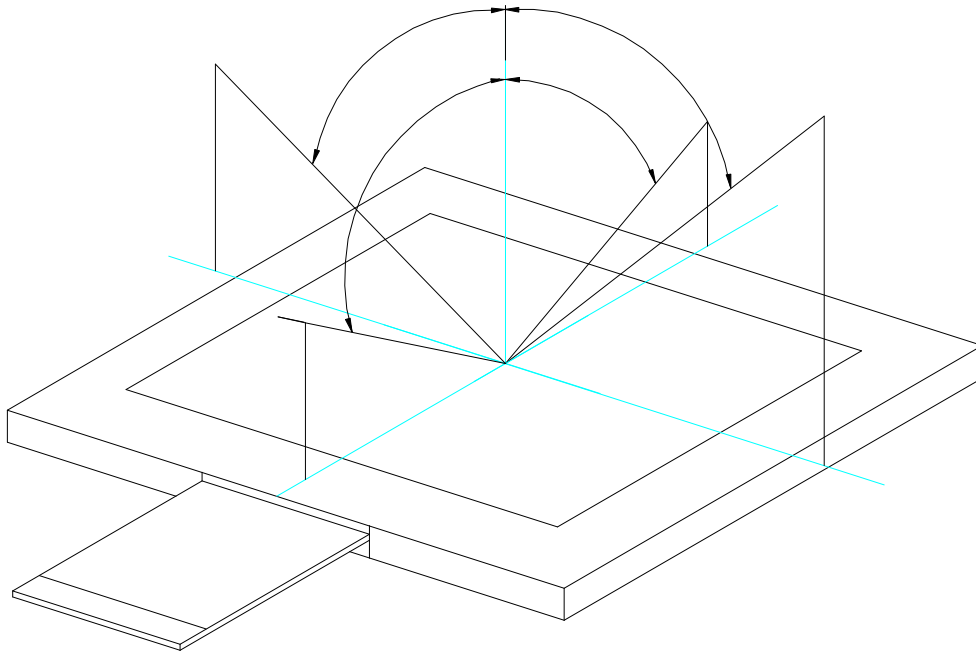


**Note 4. Definition of contrast ratio:**

Contrast ratio is calculated with the following formula.

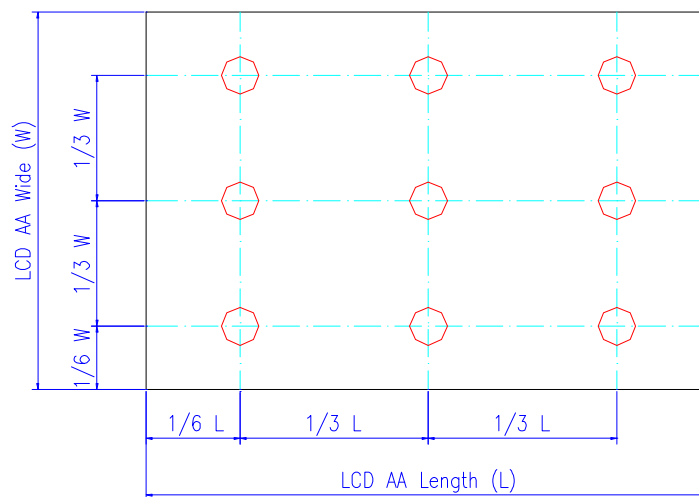
$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at "White" status}}{\text{Photo detector output when LCD is at "Black" status}}$$

**Note 5. Definition of viewing angle,  $\theta$ , Refer to figure as below.**



Note 6. Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

Note 7: Luminance Uniformity of these 9 points is defined as below:



$$\text{Uniformity} = \frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$$

## E. Reliability Test Items

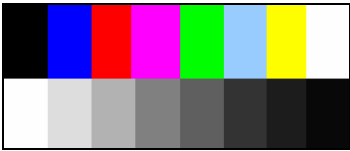
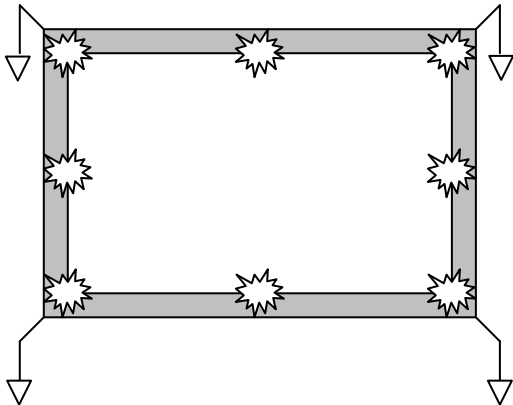
No.	Test items	Conditions	Remark
1	High Temperature Storage	Ta= 60□ 240Hrs	
2	Low Temperature Storage	Ta= -20□ 240Hrs	
3	High Temperature Operation	Tp= 50□ 240Hrs	
4	Low Temperature Operation	Ta= 0□ 240Hrs	
5	High Temperature & High Humidity	Tp= 40□ . 90% RH 240Hrs	Operation
6	Heat Shock	-20□~60□, 100 cycle, 1Hrs/cycle	Non-operation
7	Electrostatic Discharge	Contact = ± 4 kV, class B Air = ± 8 kV, class B	Note 4
8	Image Sticking	25□, 4hrs	Note 5
9	Vibration	Frequency range : 10~55Hz Stoke : 1.5mm Sweep : 10 ~ 55 ~ 10Hz 2 hours for each direction of X,Y,Z (6 hours for total)	Non-operation JIS C7021, A-10 condition A : 15 minutes
10	Mechanical Shock	100G . 6ms, ±X,±Y,±Z 3 times for each direction	Non-operation JIS C7021, A-7 condition C
11	Vibration (With Carton)	Random vibration: 0.015G <sup>2</sup> /Hz from 5~200Hz -6dB/Octave from 200~500Hz	IEC 68-34
12	Drop (With Carton)	Height: 60cm 1 corner, 3 edges, 6 surfaces	
13	Pressure	5kg, 5sec	Note 6

Note 1: Ta: Ambient Temperature. Tp: Panel Surface Temperature

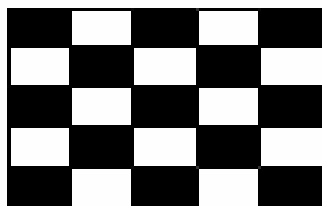
Note 2: In the standard conditions, there is not display function NG issue occurred. All the cosmetic specification is judged before the reliability stress.

Note 3: All the cosmetic specification is judged before the reliability stress.

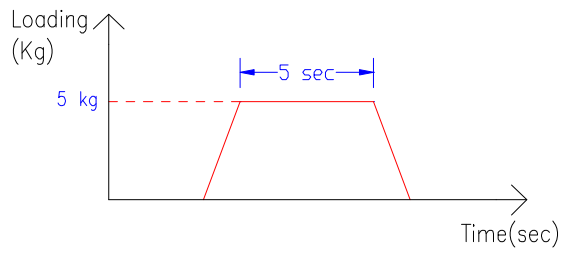
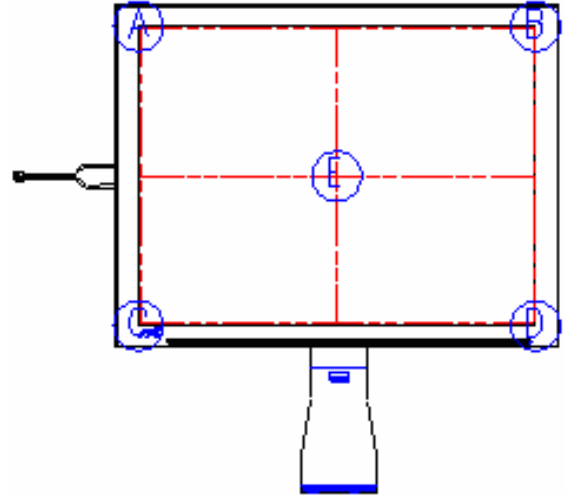
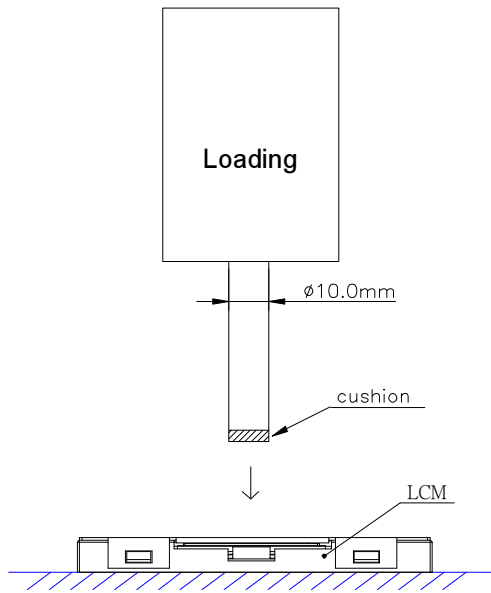
Note4 : All test techniques follow IEC6100-4-2 standard.

Test Condition		Note
Pattern		
Procedure And Set-up	<p><u>Contact Discharge</u> : 330Ω, 150pF, 1sec, 8 point, 10 times/point</p> <p><u>Air Discharge</u> : 330Ω, 150pF, 1sec, 8 point, 10 times/point</p> 	
Criteria	B – Some performance degradation allowed. No data lost. Self-recoverable hardware failure.	
Others	1. Gun to Panel Distance 2. No SPI command, keep default register settings.	

Note 5: Operate with 5x5 chess board pattern as figure and lasting time and temperature as the conditions. Then judge with 50% gray level after waiting 20 min, the mura is less than JND 2.5.

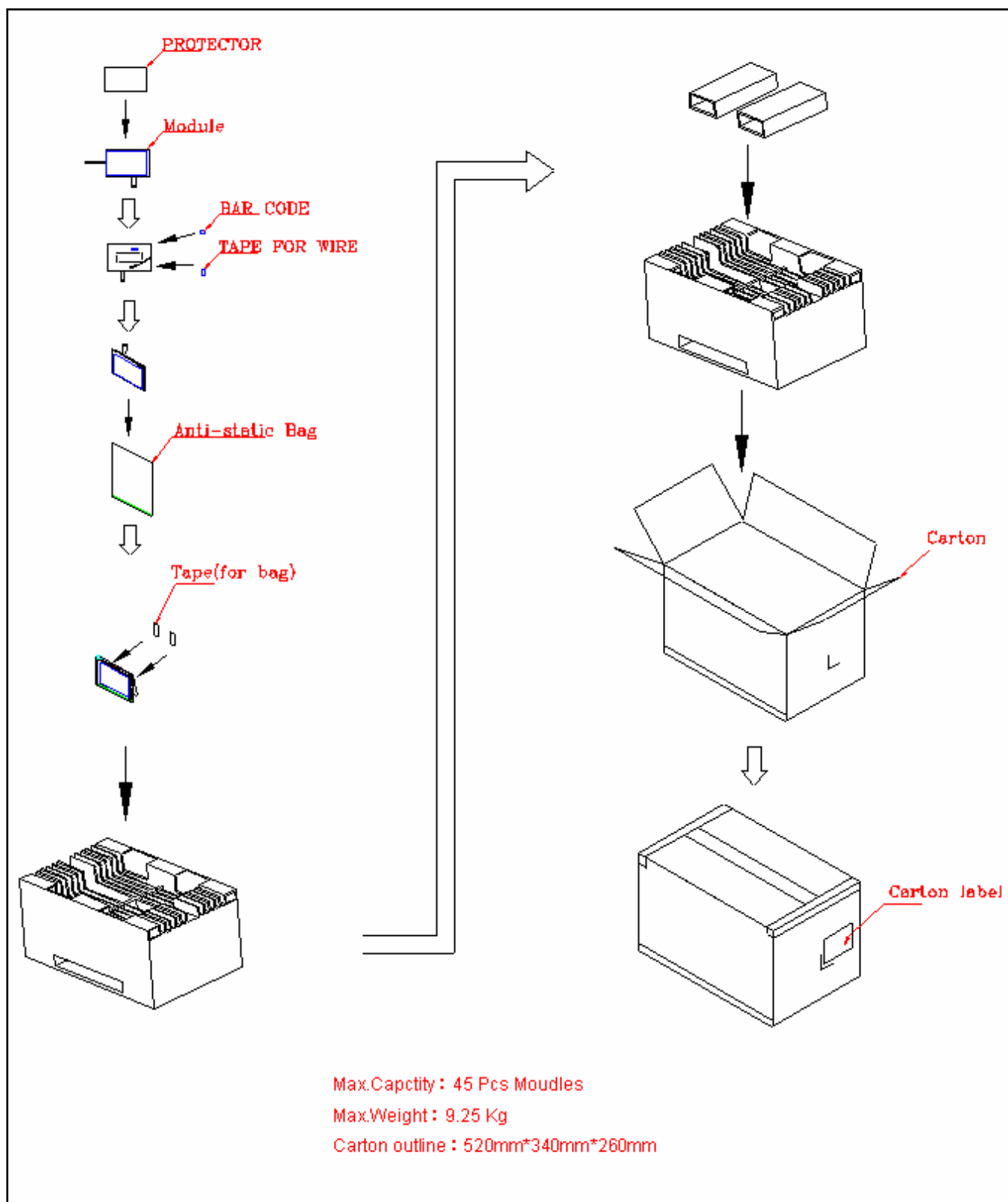


Note 6: The panel is tested as figure. The jig is  $\phi 10$  mm made by Cu with rubber and the loading speed is 3mm/min on position A~E. After the condition, no glass crack will be found and panel function check is OK.( no guarantee LC mura 、LC bubble)



## F. Packing and Marking

### 1. Packing Form



## 2. Module/Panel Label Information

The module/panel (collectively called as the "Product") will be attached with a label of Shipping Number which represents the identification of the Product at a specific location. Refer to the Product outline drawing for detailed location and size of the label. The label is composed of a 22-digit serial number and printed with code 39/128 with the following definition:

ABCDEFGHIJKLMNOPQRSTUV

- For internal system usage and production serial numbers.
- AUO Module or Panel factory code, represents the final production factory to complete the Product
- Product version code, ranging from 0~9 or A~Z (for Version after 9)
- Week Code, the production week when the product is finished at its production process

## 3. Carton Label Information

The packing carton will be attached with a carton label where packing Q'ty, AUO Model Name, AUO Part Number, Customer Part Number (Optional) and a series of Carton Number in 13 or 14 digits are printed. The Carton Number is appearing in the following format:

ABC-DEFG-HIJK-LMN

- DEFG appear after first "-" represents the packing date of the carton
- Date from 01 to 31
- Month, ranging from 1~9, A~C. A for Oct, B for Nov and C for Dec.
- A.D. year, ranging from 1~9 and 0. The single digit code represents the last number of the year

Refer to the drawing of packing format for the location and size of the carton label.



## **G. Application Note**

### **1. Application Circuit**

TBD

### **2. CABC function block**

TBD



## H. Precautions

1. Do not twist or bend the module and prevent the unsuitable external force for display module during assembly.
2. Adopt measures for good heat radiation. Be sure to use the module with in the specified temperature.
3. Avoid dust or oil mist during assembly.
4. Follow the correct power sequence while operating. Do not apply the invalid signal, otherwise, it will cause improper shut down and damage the module.
5. Less EMI: it will be more safety and less noise.
6. Please operate module in suitable temperature. The response time & brightness will drift by different temperature.
7. Avoid to display the fixed pattern (exclude the white pattern) in a long period, otherwise, it will cause image sticking.
8. Be sure to turn off the power when connecting or disconnecting the circuit.
9. Polarizer scratches easily, please handle it carefully.
10. Display surface never likes dirt or stains.
11. A dewdrop may lead to destruction. Please wipe off any moisture before using module.
12. Sudden temperature changes cause condensation, and it will cause polarizer damaged.
13. High temperature and humidity may degrade performance. Please do not expose the module to the direct sunlight and so on.
14. Acetic acid or chlorine compounds are not friends with TFT display module.
15. Static electricity will damage the module, please do not touch the module without any grounded device.
16. Do not disassemble and reassemble the module by self.
17. Be careful do not touch the rear side directly.
18. No strong vibration or shock. It will cause module broken.
19. Storage the modules in suitable environment with regular packing.
20. Be careful of injury from a broken display module.
21. Please avoid the pressure adding to the surface (front or rear side) of modules, because it will cause the display non-uniformity or other function issue.

## I. Touch Panel Command and Register Map

### 1. I2C Protocol Definition

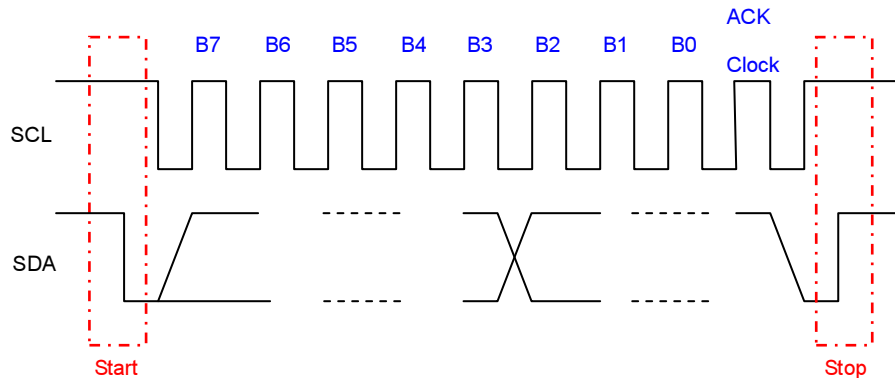


Figure 1. Standard I<sup>2</sup>C Transaction Unit

The sensor controller supports standard I<sup>2</sup>C protocol with SCL up to 400KHz. The device address is 0x5C. The chip also provides both single and sequential access. Figure 2 shows the write operation using single or sequential mode. Figure 3 also depicts the standard I2C transaction for single for sequential read mechanism.

Write Operation									
Single	Start	Device Address (W)	A	Mem Addr	A	Data[0]	A	Stop	
Sequential	Start	Device Address (W)	A	Mem Addr	A	Data[0]	A	Data[1]	A
								.....	A
								Data[n]	A
								Stop	

Figure 2. Write Operation with Single/Multiply Access

Read Operation									
Single	Start	Device Address (W)	A	Mem Addr	A	Start	Device Address (R)	A	Data[0]
								NA	Stop
Sequential	Start	Device Address (W)	A	Mem Addr	A	Start	Device Address (R)	A	Data[0]
								A	.....
								A	Data[n]
								NA	Stop

Figure 3. Read Operation with Single/Multiply Acce

[illegible]

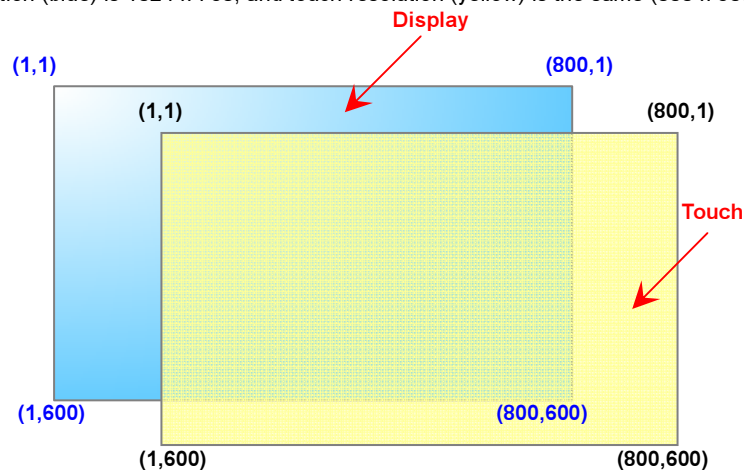
## 2. Coordinate Register Map

Addr.	Addr.(HEX)	Description	R/W	B7	B6	B5	B4	B3	B2	B1	B0
0	00	X1 (LSB)	R	X1[7]	X1[6]	X1[5]	X1[4]	X1[3]	X1[2]	X1[1]	X1[0]
1	01	X1 (MSB)	R	0	0	0	0	0	0	X1[9]	X1[8]
2	02	Y1 (LSB)	R	Y1[7]	Y1[6]	Y1[5]	Y1[4]	Y1[3]	Y1[2]	Y1[1]	Y1[0]
3	03	Y1 (MSB)	R	0	0	0	0	0	0	Y1[9]	Y1[8]
4	04	X2 (LSB)	R	X2[7]	X2[6]	X2[5]	X2[4]	X2[3]	X2[2]	X2[1]	X2[0]
5	05	X2 (MSB)	R	0	0	0	0	0	0	X2[9]	X2[8]
6	06	Y2 (LSB)	R	Y2[7]	Y2[6]	Y2[5]	Y2[4]	Y2[3]	Y2[2]	Y2[1]	Y2[0]
7	07	Y2 (MSB)	R	0	0	0	0	0	0	Y2[9]	Y2[8]

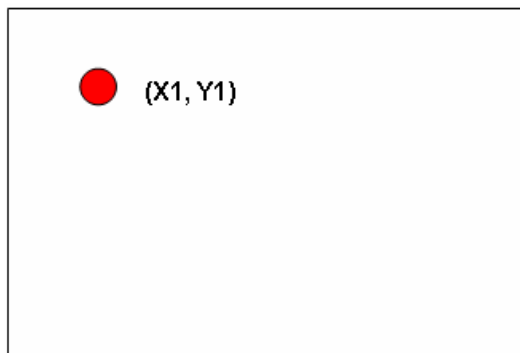
- Note: (1) (X, Y) means the touched point  
 (2) The coordinate of X1 = X1(LSB) + X1(MSB)\*256, Y1 = Y1(LSB) + Y1(MSB)\*256  
 (3) The coordinate of X2 = X2(LSB) + X2(MSB)\*256, Y2 = Y2(LSB) + Y2(MSB)\*256  
 (4) If no touch, (X1, Y1)=(0,0); (X2, Y2)=(0,0)

## 3. Display and Touch Resolution

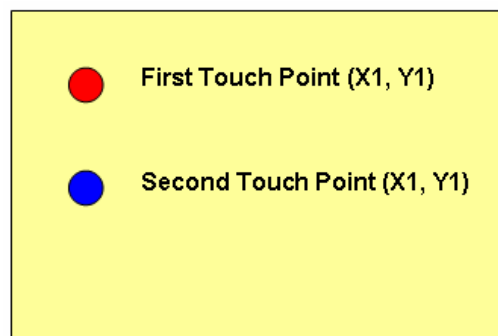
If screen resolution (blue) is 1024 x 768, and touch resolution (yellow) is the same (800 x 600)



## 4. True Two Multi-Touch



Single Touching



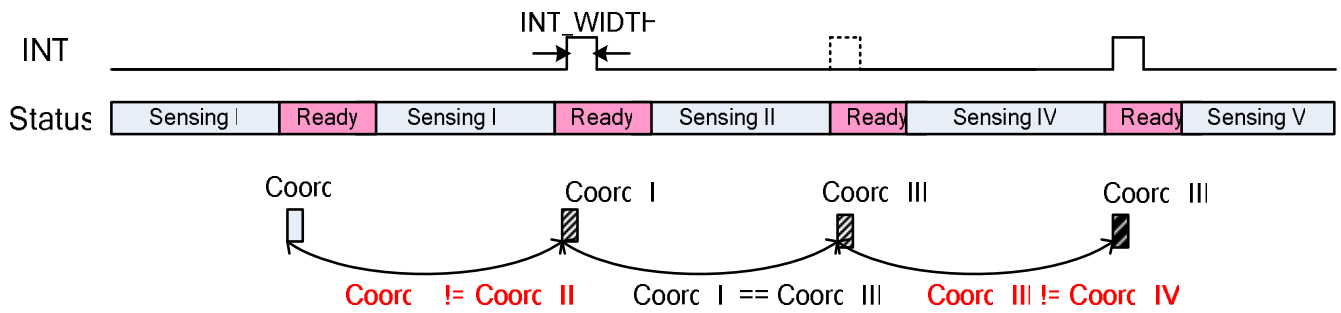
2-MultiTouch

## 5. Sensitivity

Addr.	Addr.(HEX)	Description	R/W	B7	B6	B5	B4	B3	B2	B1	B0
111	6F	X_SENSITIVITY (THRESHOLD)	R/W	X_SENSITIVITY[7:0]							
112	70	Y_SENSITIVITY (THRESHOLD)	R/W	Y_SENSITIVITY[7:0]							

Note: (1) The default value for X/Y SENSITIVITY is 0X14

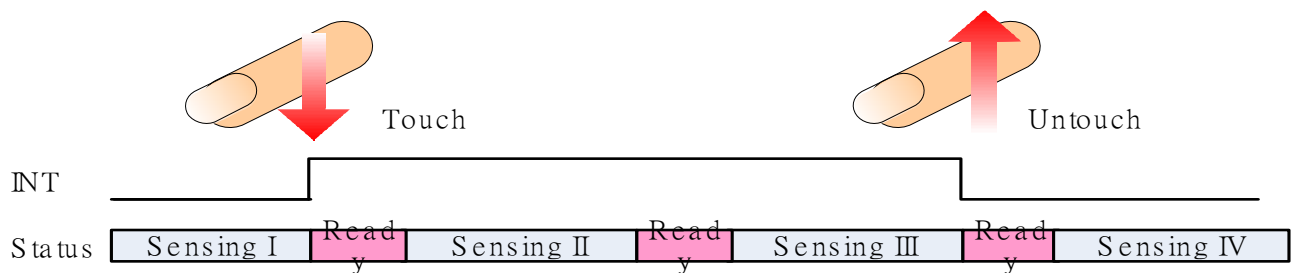




**Figure 6: Interruption Flag under Coordinate Compare Mode**

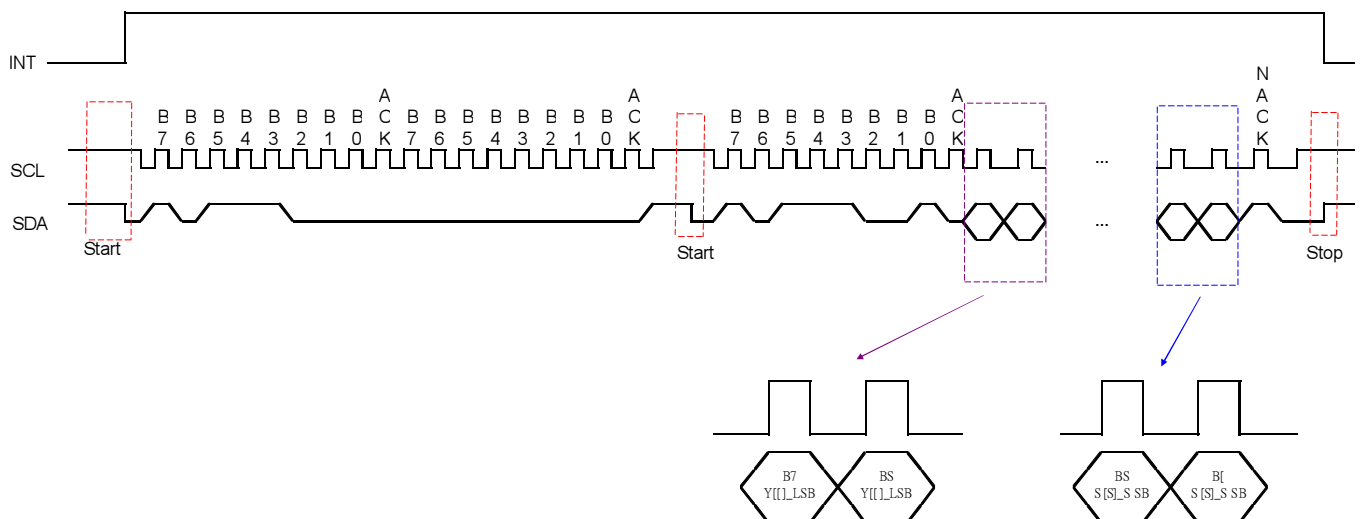
#### 6.4 Touch Indicate Mode (INT\_MODE[1:0] = [1,0]).

The interrupt will assert when the touch is valid. The interrupt should keep high until the touch is released.



### Figure 7: Touch Indicate Mode

Combination interrupt with I2C sequential read raw data operation for as following (for INT\_MODE[1:0] = [1,0])



## 7. Power Mode

Addr.	Addr.(HEX)	Description	R/W	B7	B6	B5	B4	B3	B2	B1	B0
115	73	Power Mode	R/W	IDLE_PERIOD[3]	IDLE_PERIOD[2]	IDLE_PERIOD[1]	IDLE_PERIOD[0]	0	ALLOW_SLEEP	POWER_MODE[1]	POWER_MODE[0]

The capacitive sensor controller support 3 steps of power saving: Active, Sleep, Deep Sleep, the following section describe relative scan rate and power consumption:

The default value is 0X50

### Active Mode:

The scan speed will reach 60Hz, this mode makes full-speed sensing and data process to provide best performance. the Power Mode is '0'.

### Sleep Mode:

This mode will lower the scan speed down to 10Hz. Active Mode can enter sleep mode automatically or by command. When the system issues a command to change power mode to '1', the scan rate will switch to 10Hz at next scan cycle. When allow\_sleep parameter is given, and user don't touch the screen longer than IDLE\_PERIOD ms. the controller should also enter sleep mode directly and change the scan rate to 10 Hz immediately.

When user touches the screen in **active region**, the controller should return to Active mode. besides, when system assert a command to change the power mode to '0', the scan rate should also rise to 60Hz

### Deep Sleep Mode:

When the chip enter deep sleep mode, the scan speed will reduce to 1Hz to achieve minimum power consumption. While deep sleep mode, all the registers are accessible during 4 ms, and it start from end of interrupt transition. The figure 13 and figure 14 shows a example to reference.

The only way to leave/enter deep sleep mode is change the power mode by specific command. The power mode is defined as '2'

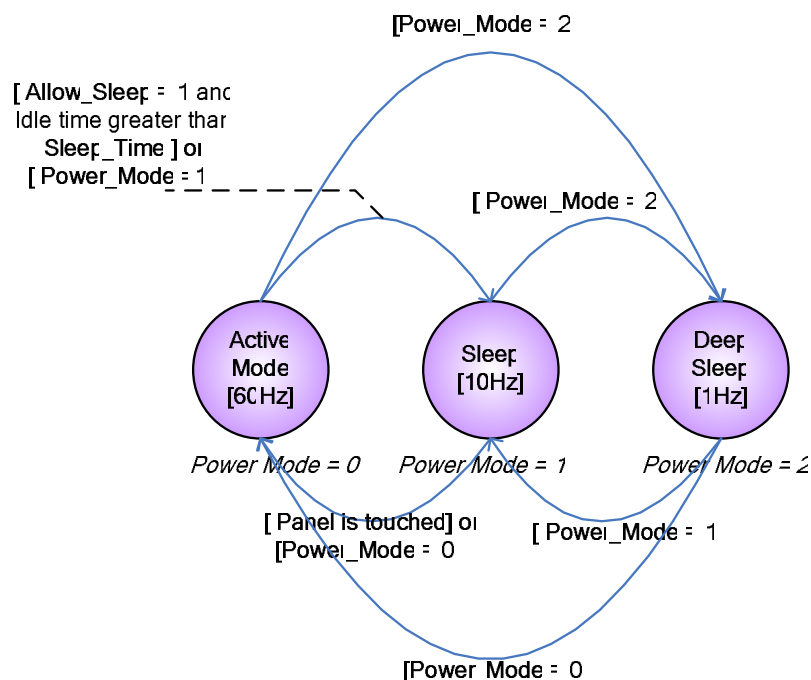


Figure 8 Power Mode Diagram

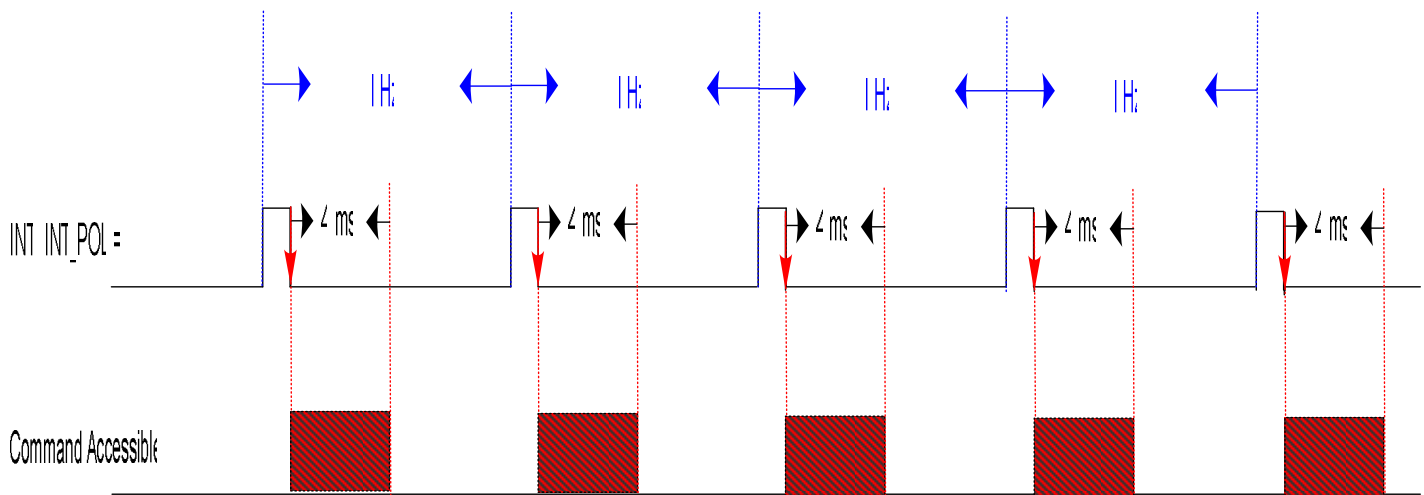


Figure 9 Command Accessible in Deep Sleep Mode (INT\_POL=1)

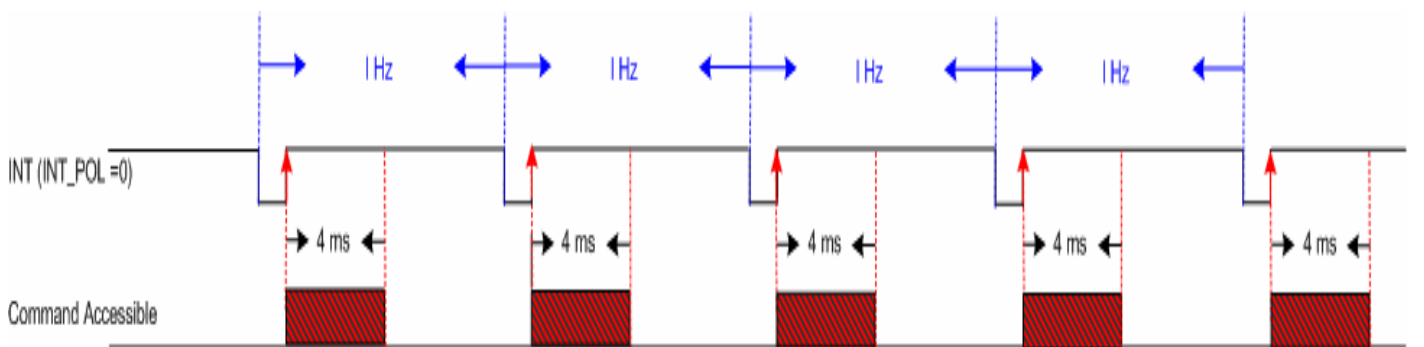


Figure 10 Command Accessible in Deep Sleep Mode (INT\_POL=0)

## 8. Calibration

Addr.	Addr.(HEX)	Description	R/W	B7	B6	B5	B4	B3	B2	B1	B0
120	78	Calibration	W	0	0	0	0	0	0	1	1

“Calibration” procedure has to be done once after assembly

Set address 0x78 as a 0x03 and wait 500ms, “Calibration” procedure will be done